












# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top	Copper	0.035mm	
5		Dielectric 1	FR-4	0.250mm	4.8
6		Ground	Copper	0.035mm	
7		Dielectric 2	FR-4	0.150mm	4.8
8		Power	Copper	0.035mm	
9		Dielectric 3	FR-4	0.250mm	4.8
10		Bottom	Copper	0.035mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 0.810mm				